

AMP-IN

TE Internal #: 61018-1

PCB Terminals, Pin, Receptacle, PCB Terminal PCB Thickness (Recommended) .063 – .094 in [1.6 – 2.39 mm], PCB Hole Diameter

4.1 mm [.161 in]

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Terminals & Splices > PCB Terminals











Terminal & Splice Type: Pin

PCB Terminal Type: Receptacle

PCB Terminal PCB Thickness (Recommended): 1.6 – 2.39 mm [.063 – .094 in]

PCB Hole Diameter: 4.1 mm [.161 in]

PCB Terminal Mating Pin Diameter: 1.47 mm [.058 in]

Features

Product Type Features	
PCB Terminal Mounting Style	Stud Mount
Terminates To	Printed Circuit Board
Configuration Features	
Stud Hole	No
Terminal Angle	Straight
Body Features	
PCB Terminal Plating Material	Pre-Tin
Contact Features	
Contact Plating Material	Tin
Terminal & Splice Type	Pin
PCB Terminal Type	Receptacle
PCB Terminal Mating Pin Diameter	1.47 mm[.058 in]
Terminal Size	Miniature
PCB Terminal Orientation	Straight



Termination Features

PCB Terminal Termination Method	Through Hole
Mechanical Attachment	
Wire Insulation Support	Without
Dimensions	
PCB Terminal PCB Thickness (Recommended)	1.6 – 2.39 mm[.063 – .094 in]
PCB Hole Diameter	4.1 mm[.161 in]
Height Above PC Board	5.33 mm[.212 in]
Receptacle Terminal Stock Thickness	.25 mm[.01 in]
Extension Below Board	3.81 mm[.15 in]
Usage Conditions	
Insulation Requirement	Uninsulated
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Packaging Features	
Packaging Quantity	1000
PCB Terminal Packaging Method	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent



chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts









Customers Also Bought





Series

















Documents



Product Drawings

.058 PCB PIN PTPPHBZ

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_61018-1_C_c-61018-1-c.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_61018-1_C_c-61018-1-c.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_61018-1_C_c-61018-1-c.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS

English

Product Specifications

Application Specification

English